



Features :

- Isolated mounting base 2500V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V _{DSM} , V _{RSM}	V _{DRM} , V _{RRM}	Type & Outline
900V	800V	MFx200-08-413F3D
1100V	1000V	MFx200-10-413F3D
1300V	1200V	MFx200-12-413F3D
1500V	1400V	MFx200-14-413F3D
1700V	1600V	MFx200-16-413F3D
1900V	1800V	MFx200-18-413F3D

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =85°C	125			200	A
I _{T(RMS)}	RMS on-state current					314	A
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			25	mA
I _{TSM}	Surge on-state current	10ms half sine wave V _R =60%V _{RRM}	125			8	kA
I ² t	I ² t for fusing coordination					320	A ² s*10 ³
V _{TO}	Threshold voltage		125			0.80	V
r _T	On-state slope resistance					1.27	mΩ
V _{TM}	Peak on-state voltage	I _{TM} =600A	25			1.65	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			800	V/μs
di/dt	Critical rate of rise of on-state current	Gate source 1.5A t _r ≤ 0.5μs Repetitive	125			100	A/μs
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25	30		180	mA
V _{GT}	Gate trigger voltage			0.7		2.5	V
I _H	Holding current			10		180	mA
V _{GD}	Non-trigger gate voltage	V _{DM} =67%V _{DRM}	125	0.2			V
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled per chip				0.14	°C /W
R _{th(c-h)}	Thermal resistance case to heatsink	Single side cooled per chip				0.04	°C /W
V _{iso}	Isolation voltage	50Hz, R.M.S, t=1min, I _{iso} : 1mA(MAX)		2500			V
F _m	Terminal connection torque(M8)				12.0		N·m
	Mounting torque(M6)				6.0		N·m
T _{vj}	Junction temperature			-40		125	°C
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				810		g
Outline	413F3D						

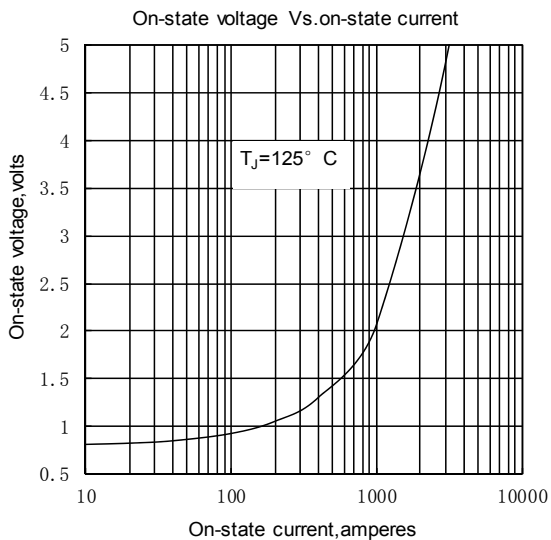


Fig.1

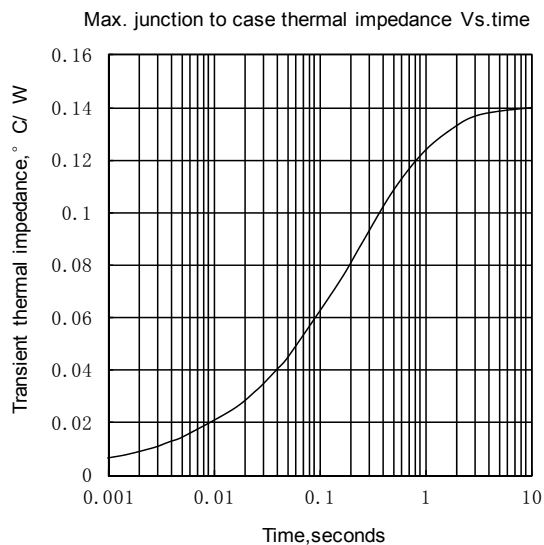


Fig.2

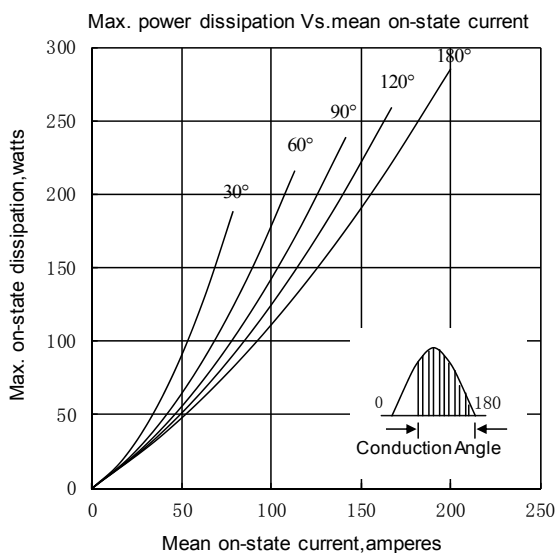


Fig.3

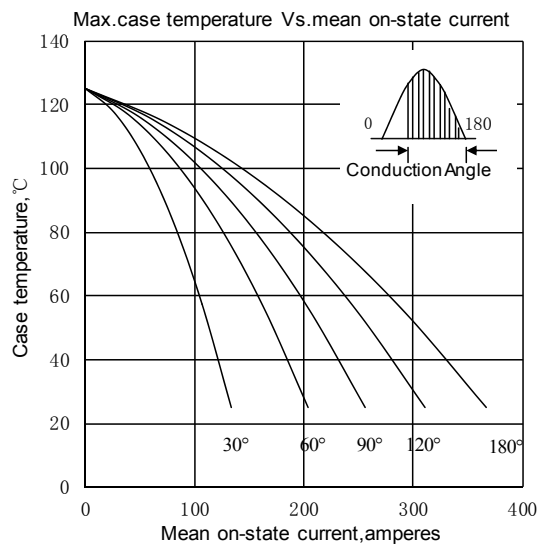


Fig.4

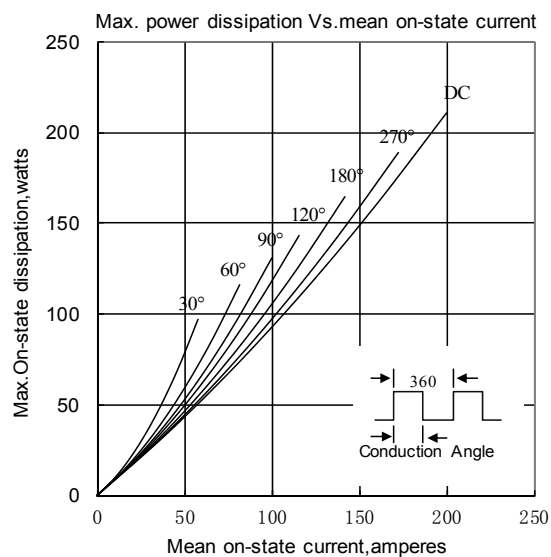


Fig.5

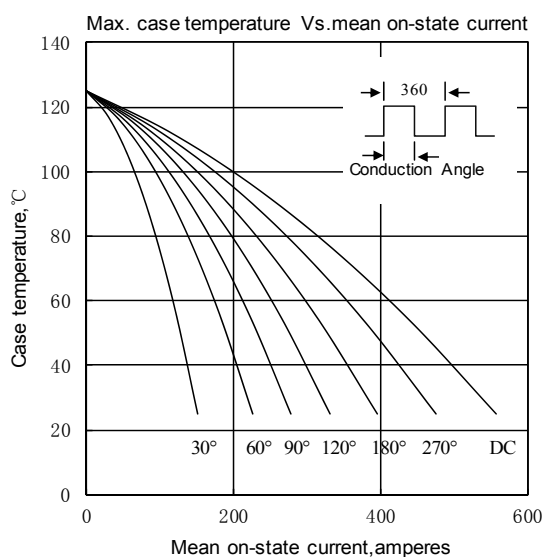


Fig.6

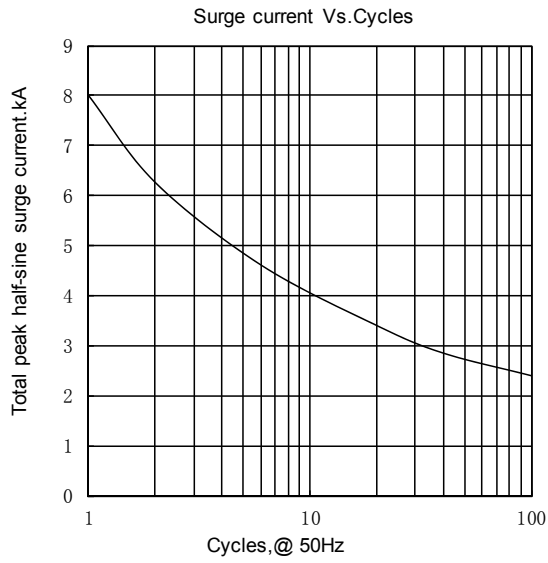


Fig.7

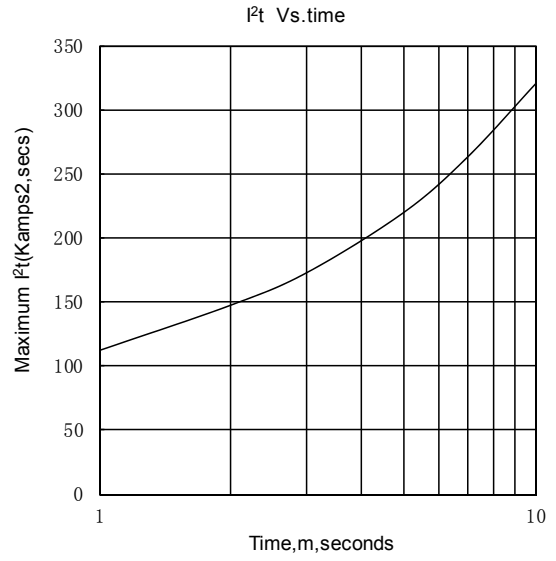


Fig.8

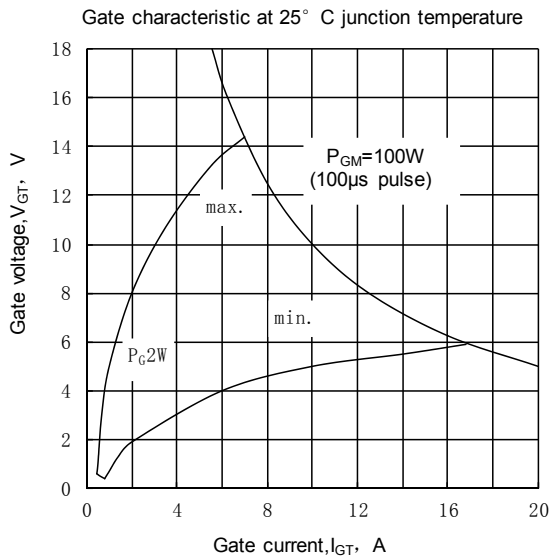


Fig.9

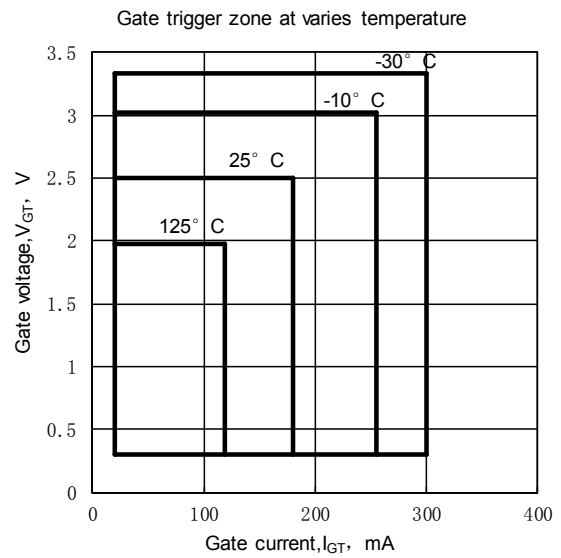
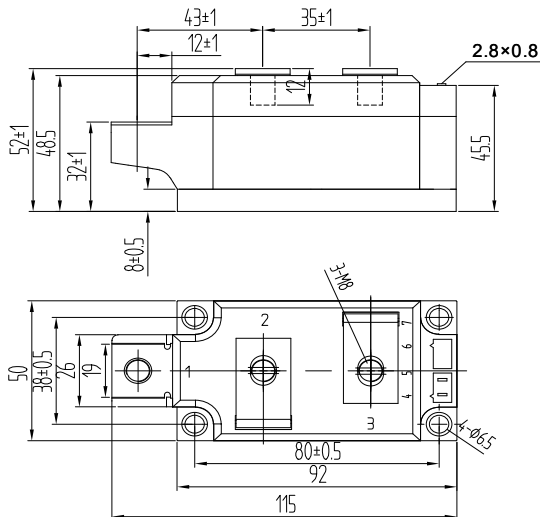
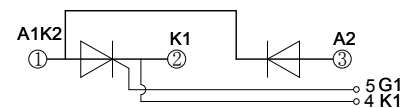


Fig.10

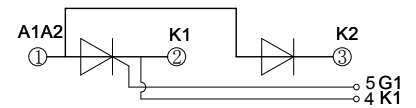
Outline:



MFC (TD)



MFA (TD)



MFK (TD)

